

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX273F, TC74LCX273FW, TC74LCX273FT

Low-Voltage Octal D-Type Flip-Flop with Clear with 5-V Tolerant Inputs and Outputs

The TC74LCX273F/FW/FT is a high-performance CMOS octal D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This 8 bit D-type flip-flop is controlled by a clock input (CK) and a clear input ($\overline{\text{CLR}}$). When the $\overline{\text{CLR}}$ input is low, the eight outputs are at a low logic level.

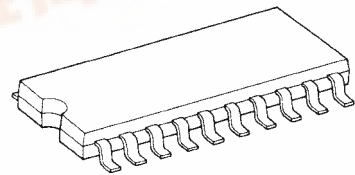
All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: $V_{CC} = 2.0$ to 3.6 V
- High-speed operation: $t_{pd} = 8.5$ ns (max) ($V_{CC} = 3.0$ to 3.6 V)
- Output current: $|I_{OH}|/I_{OL} = 24$ mA (min) ($V_{CC} = 3.0$ V)
- Latch-up performance: ± 500 mA
- Available in JEDEC SOP, JEITA SOP and TSSOP
- Power-down protection is provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 273 type

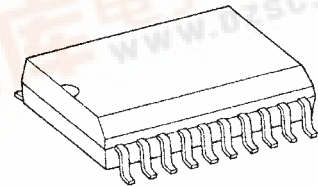
Note: xxxFW (JEDEC SOP) is not available in Japan.

TC74LCX273F



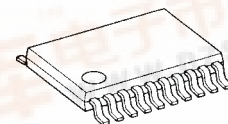
SOP20-P-300-1.27

TC74LCX273FW



SOL20-P-300-1.27

TC74LCX273FT



TSSOP20-P-0044-0.65

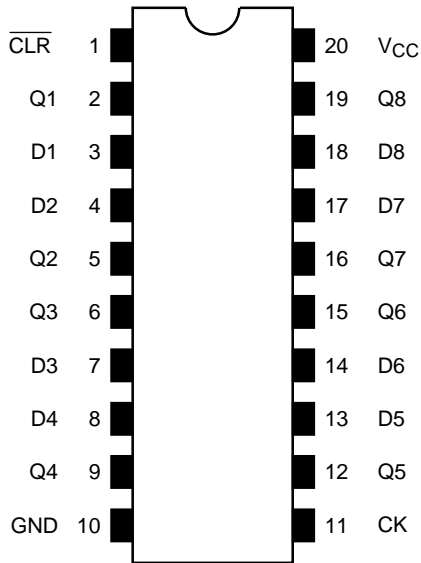
Weight

SOP20-P-300-1.27: 0.22 g (typ.)

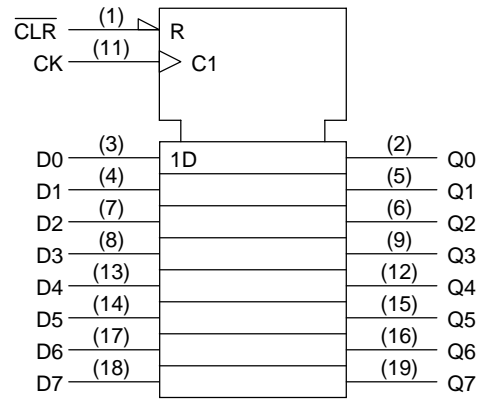
SOL20-P-300-1.27: 0.46 g (typ.)

TSSOP20-P-0044-0.65: 0.08 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol

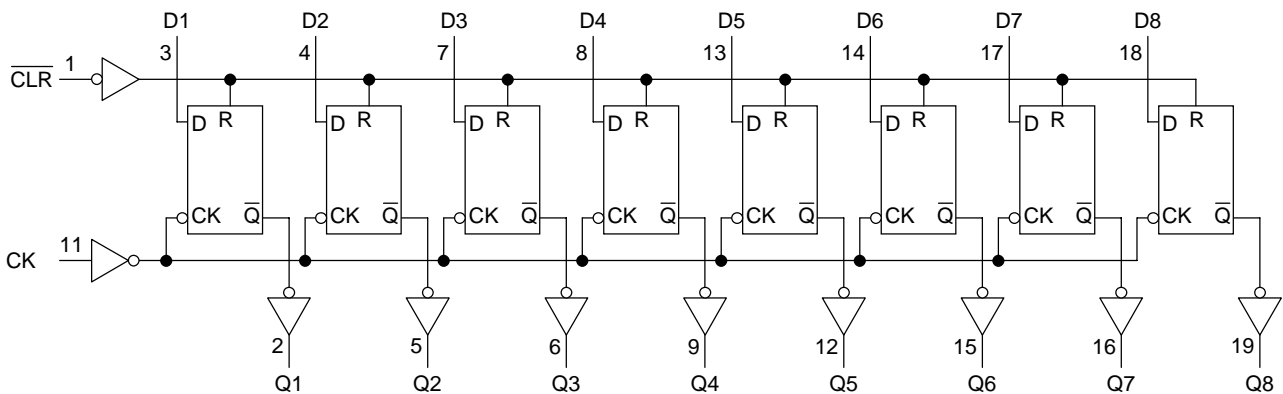


Truth Table

Inputs			Outputs	Function
$\overline{\text{CLR}}$	D	CK	Q	
L	X	X	L	Clear
H	L	\uparrow	L	—
H	H	\uparrow	H	—
H	X	\downarrow	Qn	No change

X: Don't care

System Diagram



Maximum Ratings

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	-0.5 to 7.0	V
DC input voltage	V_{IN}	-0.5 to 7.0	V
DC output voltage	V_{OUT}	-0.5 to 7.0 (Note 1)	V
		-0.5 to $V_{CC} + 0.5$ (Note 2)	
Input diode current	I_{IK}	-50	mA
Output diode current	I_{OK}	± 50 (Note 3)	mA
DC output current	I_{OUT}	± 50	mA
Power dissipation	P_D	180	mW
DC V_{CC} /ground current	I_{CC}/I_{GND}	± 100	mA
Storage temperature	T_{stg}	-65 to 150	$^{\circ}C$

Note 1: $V_{CC} = 0$ V

Note 2: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 3: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

Recommended Operating Conditions

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	2.0 to 3.6	V
		-1.5 to 3.6 (Note 4)	
Input voltage	V_{IN}	0 to 5.5	V
Output voltage	V_{OUT}	0 to 5.5 (Note 5)	V
		0 to V_{CC} (Note 6)	
Output current	I_{OH}/I_{OL}	± 24 (Note 7)	mA
		± 12 (Note 8)	
Operating temperature	T_{opr}	-40 to 85	$^{\circ}C$
Input rise and fall time	dt/dv	0 to 10 (Note 9)	ns/V

Note 4: Data retention only

Note 5: $V_{CC} = 0$ V

Note 6: High or low state

Note 7: $V_{CC} = 3.0$ to 3.6 V

Note 8: $V_{CC} = 2.7$ to 3.0 V

Note 9: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	H-level	V _{IH}			2.7 to 3.6	2.0	—	V
	L-level	V _{IL}			2.7 to 3.6	—	0.8	
Output voltage	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	—	V
				I _{OH} = -12 mA	2.7	2.2	—	
				I _{OH} = -18 mA	3.0	2.4	—	
				I _{OH} = -24 mA	3.0	2.2	—	
	L-level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	2.7 to 3.6	—	0.2	
				I _{OL} = 12 mA	2.7	—	0.4	
				I _{OL} = 16 mA	3.0	—	0.4	
				I _{OL} = 24 mA	3.0	—	0.55	
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V		2.7 to 3.6	—	±5.0	μA
Power-off leakage current		I _{OFF}	V _{IN} /V _{OUT} = 5.5 V		0	—	10.0	μA
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND		2.7 to 3.6	—	10.0	μA
			V _{IN} = 3.6 to 5.5 V		2.7 to 3.6	—	±10.0	
Increase in I _{CC} per input		ΔI _{CC}	V _{IN} = V _{CC} - 0.6 V		2.7 to 3.6	—	500	

AC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Maximum clock frequency	f _{MAX}	(Figure 1, Figure 2)			2.7	—	—	MHz
					3.3 ± 0.3	150	—	
Propagation delay time (CK-Q)	t _{PLH} t _{PHL}	(Figure 1, Figure 2)			2.7	—	9.5	ns
					3.3 ± 0.3	1.5	8.5	
Propagation delay time (CLR-Q)	t _{PHL}	(Figure 1, Figure 3)			2.7	—	9.5	ns
					3.3 ± 0.3	1.5	8.5	
Minimum pulse width (CK)	t _w (H) t _w (L)	(Figure 1, Figure 2)			2.7	3.3	—	ns
					3.3 ± 0.3	3.3	—	
Minimum pulse width (CLR)	t _w (L)	(Figure 3)			2.7	3.3	—	ns
					3.3 ± 0.3	3.3	—	
Minimum setup time	t _s	(Figure 1, Figure 2)			2.7	2.5	—	ns
					3.3 ± 0.3	2.5	—	
Minimum hold time	t _h	(Figure 1, Figure 2)			2.7	1.5	—	ns
					3.3 ± 0.3	1.5	—	
Minimum removal time	t _{rem}	(Figure 4)			2.7	2.5	—	ns
					3.3 ± 0.3	2.0	—	
Output to output skew	t _{osLH} t _{osHL}	(Note 10)			2.7	—	—	ns
					3.3 ± 0.3	—	1.0	

Note 10: Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

Dynamic Switching Characteristics

(Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition	VCC (V)	Typ.	Unit
Quiet output maximum dynamic VOL	VOLP	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V
Quiet output minimum dynamic VOL	VOLV	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	VCC (V)	Typ.	Unit
Input capacitance	C _{IN}	—	3.3	7	pF
Output capacitance	C _{OUT}		0	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note 11)	3.3	25	pF

Note 11: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

AC Test Circuit

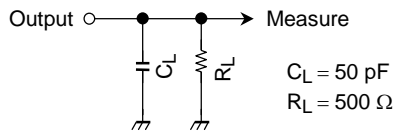


Figure 1

AC Waveform

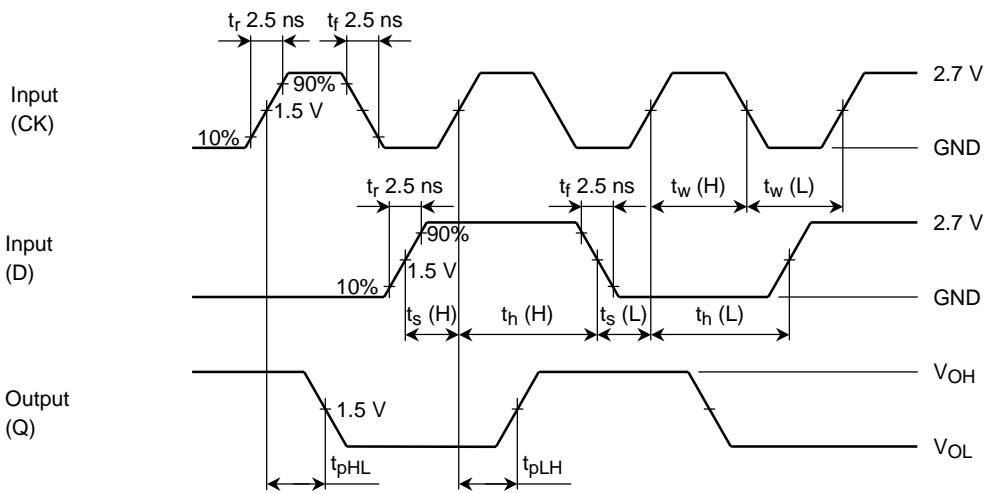


Figure 2 t_{pLH} , t_{pHL} , t_w , t_s , t_h

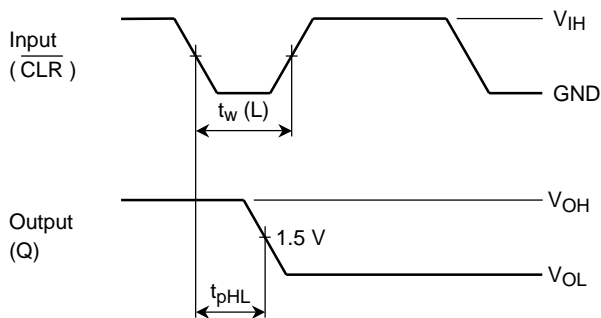


Figure 3 t_{pHL}

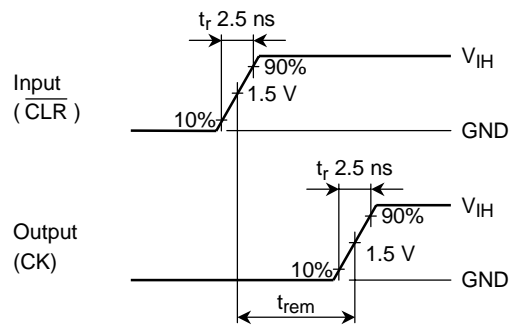
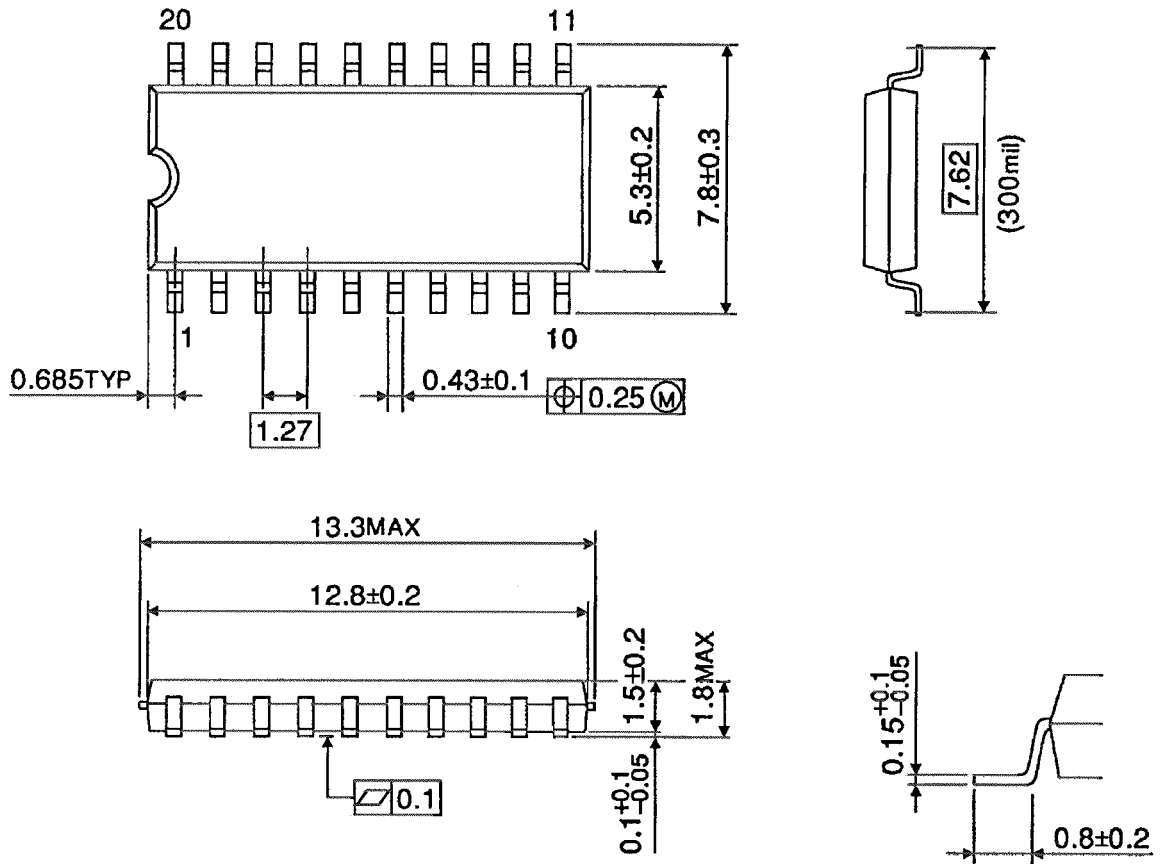


Figure 4 t_{rem}

Package Dimensions

SOP20-P-300-1.27

Unit : mm



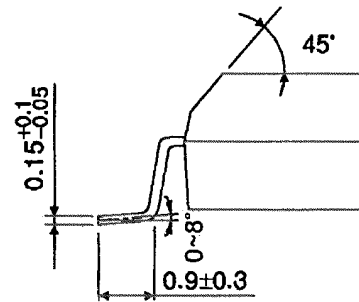
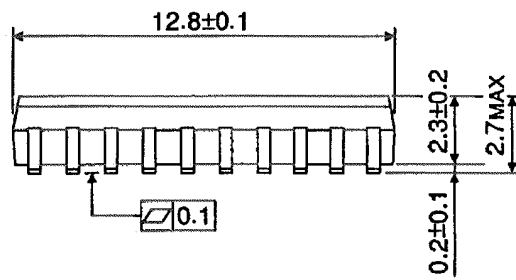
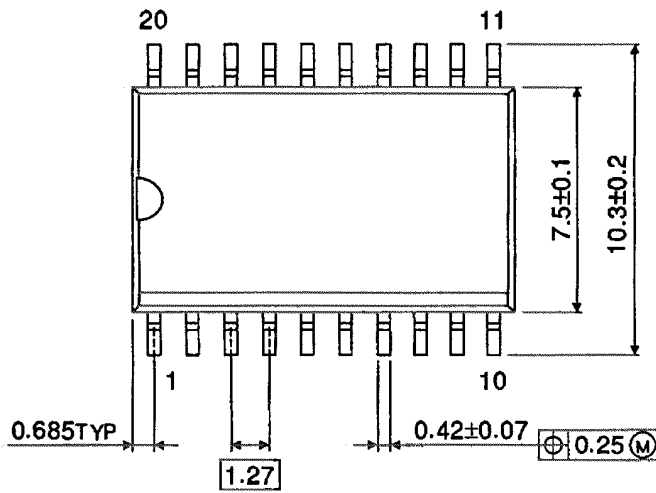
Weight: 0.22 g (typ.)

Package Dimensions

SOL20-P-300-1.27

Unit : mm

Note: This package is not available in japan.

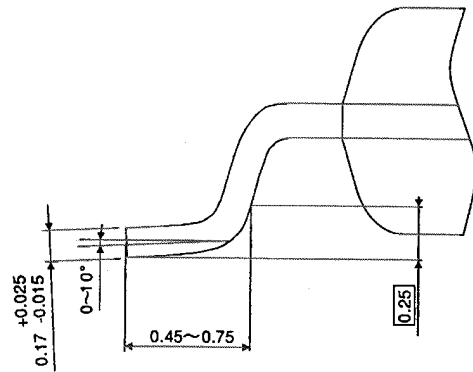
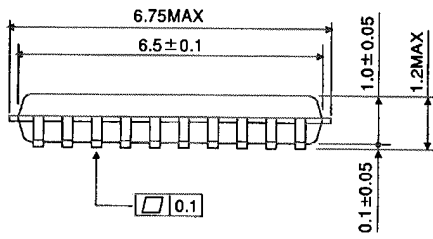
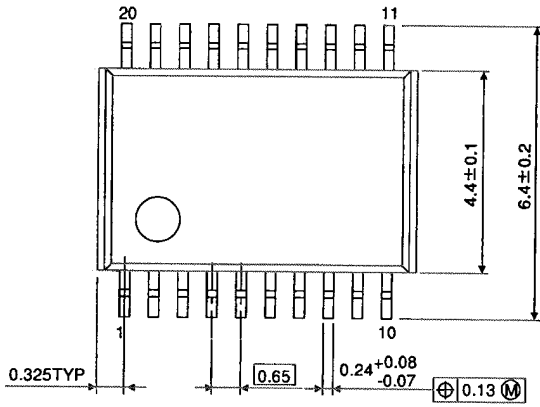


Weight: 0.46 g (typ.)

Package Dimensions

TSSOP20-P-0044-0.65

Unit : mm



Weight: 0.08 g (typ.)

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